8XC196KBxx (05 pages)

PRELIMINARY

8XC196KB/8XC196KB16
COMMERCIAL/EXPRESS CHMOS MICROCONTROLLER

- **8 Kbytes of On-Chip ROM/OTP Available**
- **232 Byte Register File**
- **Register-to-Register Architecture**
- **28 Interrupt Sources/16 Vectors**
- **1.75 μs 16 x 16 Multiply (16 MHz)**
- **3.0 μs 32/16 Divide (16 MHz)**
- **Powerdown and Idle Modes**
- **Five 8-Bit I/O Ports**
- **16-Bit Watchdog Timer**
- **12 MHz and 16 MHz Available**
- **Dedicated 15-Bit Baud Rate Generator**
- **Dynamically Configurable 8-Bit or 16-Bit Buswidth**
- **Full Duplex Serial Port**
- **High Speed I/O Subsystem**
- **16-Bit Timer**
- **16-Bit Up/Down Counter with Capture**
- **Pulse-Width-Modulated Output**
- **Four 16-Bit Software Timers**
- **10-Bit A/D Converter with Sample/Hold**
- **$\overline{\text{HOLD}}$/$\overline{\text{HLDA}}$ Bus Protocol**
- **Extended Temperature Available**

The 8XC196KB is a 16-bit microcontroller available in three different memory varieties: ROMless (80C196KB), 8K ROM (83C196KB) and 8K OTP (One Time Programmable—87C196KB). The 8XC196KB is a high performance member of the MCS® 96 microcontroller family. The 8XC196KB has the same peripheral set as the 8096BH and has a true superset of the 8096BH instructions. Intel's CHMOS process provides a high performance processor along with low power consumption. To further reduce power requirements, the processor can be placed into Idle or Powerdown Mode.

Bit, byte, word and some 32-bit operations are available on the 80C196KB. With a 16 MHz oscillator a 16-bit addition takes 0.50 μs, and the instruction times average 0.37 μs to 1.1 μs in typical applications.

Four high-speed capture inputs are provided to record times when events occur. Six high-speed outputs are available for pulse or waveform generation. The high-speed output can also generate four software timers or start an A/D conversion. Events can be based on the timer or up/down counter. Also provided on-chip are an A/D converter, serial port, watchdog timer and a pulse-width-modulated output signal.

The 8XC196KB has a maximum guaranteed frequency of 12 MHz. The 8XC196KB16 has a maximum guaranteed frequency of 16 MHz. All references to the 80C196KB also refer to the 80C196KB16; 83C196KB, Rxxx; 87C196KB and 87C196KB16 unless otherwise noted. The ROM device does not have a speed indicator at the end of the device name. Instead it has a ROM code number.

With the commercial (standard) temperature option, operational characteristics are guaranteed over the temperature range of 0°C to +70°C. With the extended temperature range option, operational characteristics are guaranteed over the temperature range of −40°C to +85°C.

Package Designators: N = 68-pin PLCC, S = 80-pin QFP (commercial only). Prefix Designators: T = Extended Temperature.

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*Other brands and names are the property of their respective owners.

July 1994 **Order Number: 270909-006**

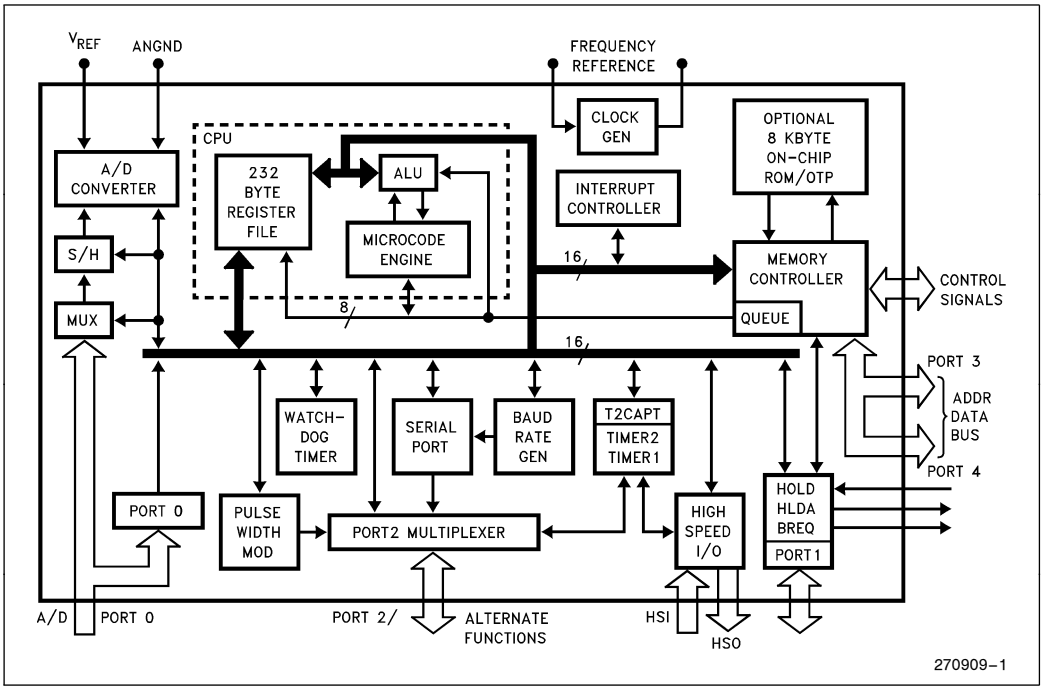
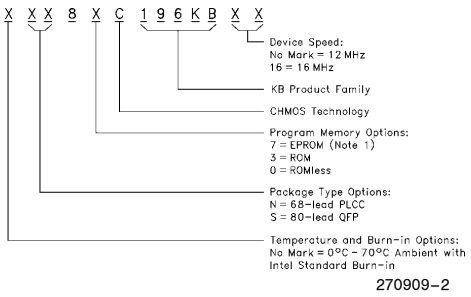


Figure 1. 8XC196KB Block Diagram

PROCESS INFORMATION

This device is manufactured on P629.0 and 629.1, a CHMOS III-E process. Additional process and reliability information is available in Intel's *Components Quality and Reliability Handbook,* Order Number 210997.



EXAMPLE: N87C196KB16 is 68-Lead PLCC OTPROM, 16 MHz.
For complete package dimensional data, refer to the Intel Packaging Handbook (Order Number 240800).

NOTE:
1. EPROMs are available as One Time Programmable (OTPROM) only.

Figure 2. The 8XC196KB Nomenclature

Table 1. Thermal Characteristics

Package Type	θ_{ja}	θ_{jc}
PLCC	35°C/W	13°C/W
QFP	70°C/W	4°C/W

All thermal impedance data is approximate for static air conditions at 1W of power dissipation. Values will change depending on operation conditions and application. See the Intel *Packaging Handbook* (order number 240800) for a description of Intel's thermal impedance test methodology.

Table 2. 8XC196KB Memory Map

Description	Address
External Memory or I/O	0FFFFH 04000H
Internal ROM/EPROM or External Memory (Determined by $\overline{EA}$)	3FFFH 2080H
Reserved. Must contain FFH. (Note 5)	207FH 2040H
Upper Interrupt Vectors	203FH 2030H
ROM/EPROM Security Key	202FH 2020H
Reserved. Must contain FFH. (Note 5)	201FH 201AH
Reserved. Must Contain 20H (Note 5)	2019H
CCB	2018H
Reserved. Must contain FFH. (Note 5)	2017H 2014H
Lower Interrupt Vectors	2013H 2000H
Port 3 and Port 4	1FFFH 1FFEH
External Memory	1FFDH 0100H
232 Bytes Register RAM (Note 1)	00FFH 0018H
CPU SFR's (Notes 1, 3)	0017H 0000H

NOTES:
1. Code executed in locations 0000H to 00FFH will be forced external.
2. Reserved memory locations must contain 0FFH unless noted.
3. Reserved SFR bit locations must contain 0.
4. Refer to 8XC196KB quick reference for SFR descriptions.
5. **WARNING:** Reserved memory locations must not be written or read. The contents and/or function of these locations may change with future revisions of the device. Therefore, a program that relies on one or more of these locations may not function properly.

PIN DESCRIPTIONS

Symbol	Name and Function
V_{CC}	Main supply voltage (5V).
V_{SS}	Digital circuit ground (0V). There are multiple V_{SS} pins, all of them must be connected.
V_{REF}	Reference voltage for the A/D converter (5V). V_{REF} is also the supply voltage to the analog portion of the A/D converter and the logic used to read Port 0. Must be connected for A/D and Port 0 to function.
ANGND	Reference ground for the A/D converter. Must be held at nominally the same potential as V_{SS}. Connect V_{SS} and ANGND at chip to avoid noise problems.
V_{PP}	Programming voltage. Also timing pin for the return from power down circuit.
XTAL1	Input of the oscillator inverter and of the internal clock generator.
XTAL2	Output of the oscillator inverter.
CLKOUT	Output of the internal clock generator. The frequency of CLKOUT is ½ the oscillator frequency. It has a 50% duty cycle.
$\overline{\text{RESET}}$	Reset input to and open-drain output from the chip. Input low for at least 4 state times to reset the chip. The subsequent low-to-high transition re-synchronizes CLKOUT and commences a 10-state-time RESET sequence.
BUSWIDTH	Input for buswidth selection. If CCR bit 1 is a one, this pin selects the bus width for the bus cycle in progress. If BUSWIDTH is a 1, a 16-bit bus cycle occurs. If BUSWIDTH is a 0 an 8-bit cycle occurs. If CCR bit 1 is a 0, the bus is always an 8-bit bus.
NMI	A positive transition causes a vector through 203EH.
INST	Output high during an external memory read indicates the read is an instruction fetch and output low indicates a data fetch. INST is valid throughout the bus cycle. INST is activated only during external memory accesses.
$\overline{\text{EA}}$	Input for memory select (External Access). $\overline{\text{EA}}$ equal to a TTL-high causes memory accesses to locations 2000H through 3FFFH to be directed to on-chip ROM/OTPROM. $\overline{\text{EA}}$ equal to a TTL-low causes accesses to these locations to be directed to off-chip memory.
ALE/$\overline{\text{ADV}}$	Address Latch Enable or Address Valid output, as selected by CCR. Both pin options provide a latch to demultiplex the address from the address/data bus. When the pin is $\overline{\text{ADV}}$, it goes inactive high at the end of the bus cycle. ALE/$\overline{\text{ADV}}$ is activated only during external memory accesses.
$\overline{\text{RD}}$	Read signal output to external memory. $\overline{\text{RD}}$ is activated only during external memory reads.
$\overline{\text{WR}}$/$\overline{\text{WRL}}$	Write and Write Low output to external memory, as selected by the CCR. $\overline{\text{WR}}$ will go low for every external write, while $\overline{\text{WRL}}$ will go low only for external writes where an even byte is being written. $\overline{\text{WR}}$/$\overline{\text{WRL}}$ is activated only during external memory writes.
$\overline{\text{BHE}}$/$\overline{\text{WRH}}$	Bus High Enable or Write High output to external memory, as selected by the CCR. $\overline{\text{BHE}}$ will go low for external writes to the high byte of the data bus. $\overline{\text{WRH}}$ will go low for external writes where an odd byte is being addressed. $\overline{\text{BHE}}$/$\overline{\text{WRH}}$ is activated only during external memory writes.
READY	Ready input to lengthen external memory cycles. If the pin is low prior to the falling edge of CLKOUT, the memory controller goes into a wait mode until the next positive transition in CLKOUT occurs with READY high. When the external memory is not being used, READY has no effect. Internal control of the number of wait states inserted into a bus cycle (held not ready) is available in the CCR.
HSI	Inputs to High Speed Input Unit. Four HSI pins are available: HSI.0, HSI.1, HSI.2 and HSI.3. Two of them (HSI.2 and HSI.3) are shared with the HSO Unit.
HSO	Outputs from High Speed Output Unit. Six HSO pins are available: HSO.0, HSO.1, HSO.2, HSO.3, HSO.4 and HSO.5. Two of them (HSO.4 and HSO.5) are shared with the HSI Unit.

PIN DESCRIPTIONS (Continued)

Symbol	Name and Function
Port 0	8-bit high impedance input-only port. Three pins can be used as digital inputs and/or as analog inputs to the on-chip A/D converter.
Port 1	8-bit quasi-bidirectional I/O port. These pins are shared with $\overline{\text{HOLD}}$, $\overline{\text{HLDA}}$ and $\overline{\text{BREQ}}$.
Port 2	8-bit multi-functional port. All of its pins are shared with other functions in the 87C196KB. Pins P2.6 and P2.7 are quasi-bidirectional.
Ports 3 and 4	8-bit bidirectional I/O ports with open drain outputs. These pins are shared with the multiplexed address/data bus, which has strong internal pullups.
$\overline{\text{HOLD}}$	Bus Hold input requesting control of the bus. Enabled by setting WSR.7.
$\overline{\text{HLDA}}$	Bus Hold acknowledge output indicating release of the bus. Enabled by setting WSR.7.
$\overline{\text{BREQ}}$	Bus Request output activated when the bus controller has a pending external memory cycle. Enabled by setting WSR.7.
TxD	The TxD pin is used for serial port transmission in Modes 1, 2 and 3. In Mode 0 the pin is used as the serial clock output.
RxD	Serial Port Receive pin used for serial port reception. In Mode 0 the pin functions as input or output data.
EXTINT	A rising edge on the EXTINT pin will generate an external interrupt.
T2CLK	The T2CLK pin is the Timer2 clock input or the serial port baud rate generator input.
T2RST	A rising edge on the T2RST pin will reset Timer2.
PWM	The pulse width modulator output.
T2UP-DN	The T2UPDN pin controls the direction of Timer2 as an up or down counter.
T2CAPTURE	A rising edge on P2.7 will capture the value of Timer2 in the T2CAPTURE register.
PMODE	Programming Mode Select. Determines the EPROM programming algorithm that is performed. PMODE is sampled after a chip reset and should be static while the part is operating.
SID	Slave ID Number. Used to assign each slave a pin of Port 3 or 4 to use for passing programming verification acknowledgement.
$\overline{\text{PALE}}$	Programming ALE Input. Accepted by the 87C196KB when it is in Slave Programming Mode. Used to indicate that Ports 3 and 4 contain a command/address.
$\overline{\text{PROG}}$	Programming. Falling edge indicates valid data on PBUS and the beginning of programming. Rising edge indicates end of programming.
$\overline{\text{PACT}}$	Programming Active. Used in the Auto Programming Mode to indicate when programming activity is complete.
$\overline{\text{PVAL}}$	Program Valid. This signal indicates the success or failure of programming in the Auto Programming Mode. A zero indicates successful programming.
PVER	Program Verification. Used in Slave Programming and Auto CLB Programming Modes. Signal is low after rising edge of PROG if the programming was not successful.
$\overline{\text{AINC}}$	Auto Increment. Active low signal indicates that the auto increment mode is enabled. Auto Increment will allow reading or writing of sequential EPROM locations without address transactions across the PBUS for each read or write.
Ports 3 and 4 (Programming Mode)	Address/Command/Data Bus. Used to pass commands, addresses, and data to and from slave mode 87C196KBs. Used by chips in Auto Programming Mode to pass command, addresses and data to slaves. Also used in the Auto Programming Mode as a regular system bus to access external memory. Should have pullups to V_{CC} when used in slave programming mode.